502708956 03/06/2014

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2755561

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WOOKJUN CHUNG	02/11/2014
JAEMYUNG LIM	02/11/2014
BYEONGKOOK KIM	02/11/2014
JUNGHOI CHOI	02/13/2014

RECEIVING PARTY DATA

Name:	LG ELECTRONICS INC.
Street Address:	128, YEOUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	150-721

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29484093

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ATTORNEY DOCKET NUMBER:	001082-7308
NAME OF SUBMITTER:	ROBERT J. GOODELL
Signature:	/Robert J. Goodell/
	PATENT

502708956 REEL: 032363 FRAME: 0436

Date: 03/06/2014

Total Attachments: 2
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PATENT REEL: 032363 FRAME: 0437

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ATTORNEY DOCKET NO.: SOLE/JOINT INVENTION (U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have

made an invention entitled:	min (o), fundament revenue to an energy			
MAIN BODY FOR CLOTHES MANAGEMENT APPARATUS for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on, (Application No); and				
WHEREAS, LG ELECTRONICS INC., a corporation of Republic of Korea, whose post office address is 128, Yeoui-daero, Yeongdeungpo-gu, Seoul, 150-721, Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;				
NOW THEREFORE, be it known that, ffrom assignee is hereby acknowledged, I/WE, as and do hereby sell, assign, transfer, and set over MY/OUR entire right, title, and interest in and to continuations thereof, and all Letters Patent of the reissues thereof; and I/WE hereby authorize and the United States to issue all Letters Patent for the accordance with the terms of this Assignment;	o this invention and this application, and all the United States which may be granted there over the Commissioner of Patents and	ed, and set over, d assigns, I divisions, and eon, and all Frademarks of		
AND, I/WE HEREBY further covenant communicate with assignee, its successors and a invention and testify in any legal proceeding, sign and deliver all papers that may be necessary or cassignee, its successors and assigns, execute all all rightful oaths and generally do everything pound enforce proper patent protection for this invexpense incident to the execution of such papers	gn all lawful papers when called upon to de desirable to perfect the title to this invention divisional, continuation, and reissue applicates and assignee, its successors and assignee, its successors and assignee, its being unders	o so, execute in in said ations, make ssigns, to obtain tood that any		
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No, filed) the filing date and application number of said application when known. IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).				
Full Name of First Assignor	Assignor's Signature	Date		
Wookiun CHUNG		パレ.ユ.川 Citizenship		
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Full Name of Second Assignor	Assignor's Signature	Date 14, 2, 4		
Jaemyung LIM		Citizenship		
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Number of additional inventors attached Myes No				
Names of additional inventors attached Yes No				

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Full Name of Third Assignor Byeongkook KIM	Assignor's Signature	Date 14. 2.11
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Full Name of Fourth Assignor Junghoi CHOI	Assignor's Signature	Date 14. 2.13
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Names of additional inventors attached Yes	⊠ No	

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